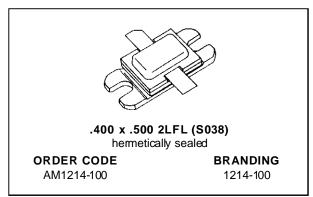


# AM1214-100

# RF & MICROWAVE TRANSISTORS L-BAND RADAR APPLICATIONS

PRELIMINARY DATA

- REFRACTORY/GOLD METALLIZATION
- EMITTER SITE BALLASTED
- LOW THERMAL RESISTANCE
- INPUT/OUTPUT MATCHING
- OVERLAY GEOMETRY
- METAL/CERAMIC HERMETIC PACKAGE
- P<sub>OUT</sub> = 100 W MIN. WITH 6.0 dB GAIN

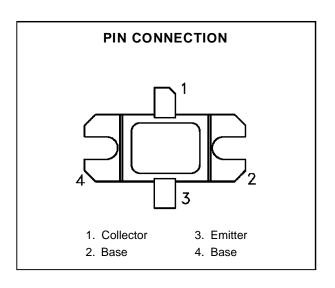


#### DESCRIPTION

The AM1214-100 device is a high power Class C transistor specifically designed for L-Band Radar pulsed driver applications.

This device is capable of operation over a wide range of pulse widths, duty cycles, and temperatures and is capable of withstanding 3:1 output VSWR at rated RF conditions. Low RF thermal resistance and computerized automatic wire bonding techniques ensure high reliability and product consistency.

AM1214-100 is supplied in the grounded IMPAC<sup>TM</sup> hermetic metal/ceramic package with internal input/output matching structures.



#### **ABSOLUTE MAXIMUM RATINGS** $(T_{case} = 25^{\circ}C)$

Symbol	Parameter	Value	Unit	
P <sub>DISS</sub>	Power Dissipation* (T <sub>C</sub> ≤ 100°C)	270	W	
Ic	Device Current*	13.5	А	
Vcc	Collector-Supply Voltage*	32	V	
TJ	Junction Temperature (Pulsed RF Operation)	250	°C	
T <sub>STG</sub>	Storage Temperature	- 65 to +200	°C	

#### THERMAL DATA

R <sub>TH(j-c)</sub>	Junction-Case Thermal Resistance*	0.55	°C/W

<sup>\*</sup>Applies only to rated RF amplifier operation

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# **ELECTRICAL SPECIFICATIONS** (Tcase = 25°C)

## STATIC

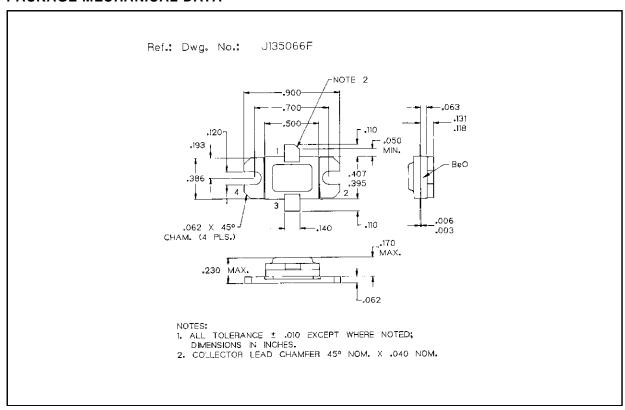
			Value			
Symbol		Test Conditions	Min.	Тур.	Max.	Unit
ВУсво	I <sub>C</sub> = 50mA	$I_E = 0mA$	65	_		V
BV <sub>EBO</sub>	I <sub>E</sub> = 10mA	$I_C = 0mA$	3.5			V
BV <sub>CES</sub>	IC = 100mA		65		_	V
Ices	V <sub>BE</sub> = 0V	$V_{CE} = 32V$	_		20	mA
hFE	V <sub>CE</sub> = 5V	$I_C = 5A$	15			_

## **DYNAMIC**

				Value			
Symbol	Test Conditions			Min.	Тур.	Max.	Unit
Pout	f = 1215 — 1400MHz P	$P_{IN} = 25W$	$V_{CC} = 28V$	100	_		W
ης	f = 1215 — 1400MHz P	$P_{IN} = 25W$	$V_{CC} = 28V$	50	_		%
G <sub>P</sub>	f = 1215 — 1400MHz P	$P_{IN} = 25W$	$V_{CC} = 28V$	6.0	_	_	dB

Note: Pulse Width =  $100\mu Sec$ Duty Cycle = 10%

### PACKAGE MECHANICAL DATA



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